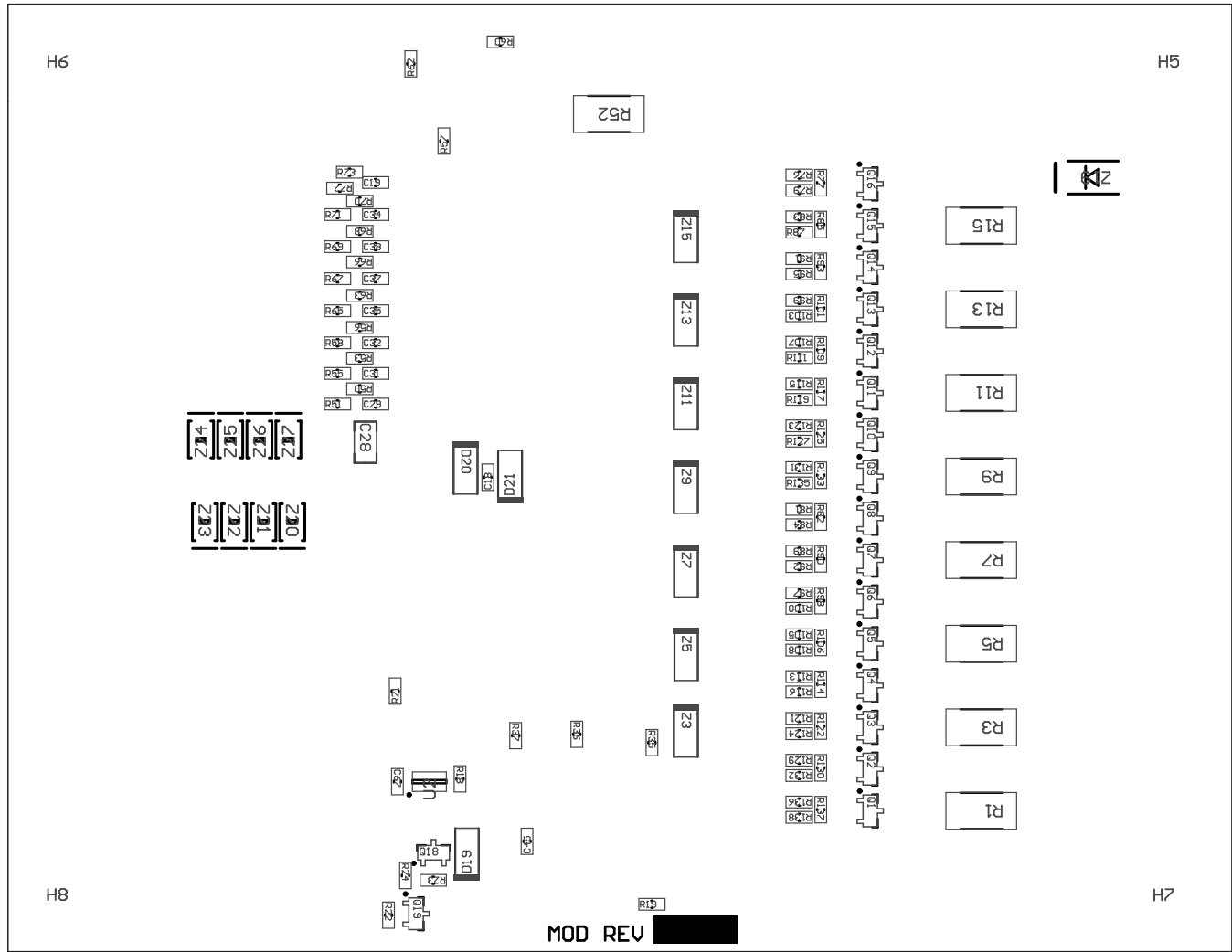


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS
 ASSEMBLY VARIANT: -100A

PCB VIEWED FROM TOP SIDE	PROJECT NAME = bq76PL455EVM	
LAYER NAME = Top Overlay	ARTWORK # = 880.prj_Base PCB Copper Rev	TEXAS INSTRUMENTS
PLOT NAME = Top Assembly Drawing	GENERATED	: 4/21/2014 1:12:01 PM



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS
 ASSEMBLY VARIANT: -100A

PCB VIEWED FROM BOTTOM SIDE	PROJECT NAME = bq76PL455EUM	
LAYER NAME =	ARTWORK 088 = 880.pr j_Base PCB Copied Rev 1	TEXAS INSTRUMENTS
PLOT NAME = Bottom Assembly Drawing	GENERATED	: 4/21/2014 1:12:06 PM

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